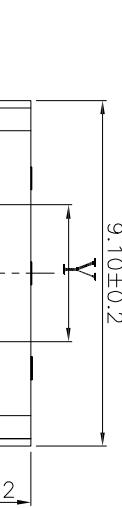


**RoHS**

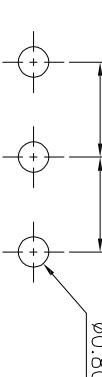
CAD GENERATED DRAWING, DON'T CHANGE BY HAND.

REV.	ECN. NO.	APPD.
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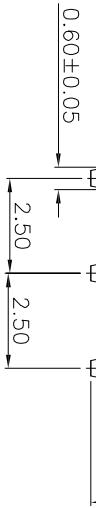
### 手柄尺寸

F	K	Y
1.5*1.5	1.6	3.6
2.0*2.0	2.1	4.0

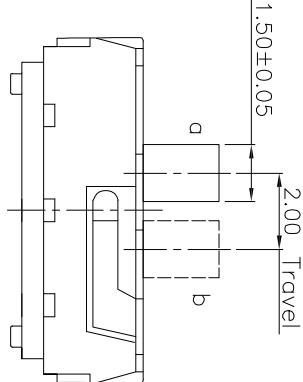


### P C B MOUNTING PATTERN DIMENSION

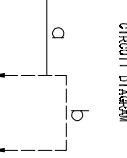
The following table indicates the recommended  
for refloc soldering



C



D

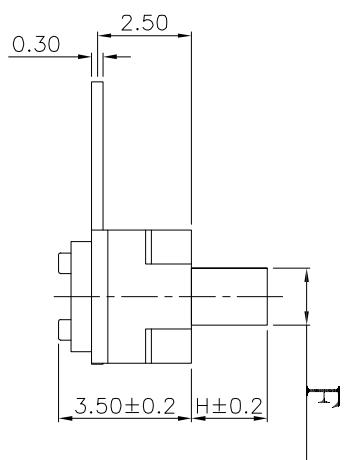


CIRCUIT DIAGRAM

E

Specification	Part Name	Material	Specification
Operating Life	10,000	Silver plate	Silver plating of stainless steel
Contact rating	300mA@4V DC.	button	black PA6/9T
Insulation resistance	>10Ω	spring	ecru Stainless steel wire
Contact resistance	≤100MΩ	reed	silver Phosphor bronze plated
Dielectric Strength	250 V 50HZ 1min	base	black PA6/9T/LCP
Travel	0.2±0.1mm	terminal	silver Phosphor copper plating silver

### Mechanical



Specified

F

G

H

I

Specification	Part Name	Material	Specification
Operating Life	10,000	Silver plate	Silver plating of stainless steel
Contact rating	300mA@4V DC.	button	black PA6/9T
Insulation resistance	>10Ω	spring	ecru Stainless steel wire
Contact resistance	≤100MΩ	reed	silver Phosphor bronze plated
Dielectric Strength	250 V 50HZ 1min	base	black PA6/9T/LCP
Travel	0.2±0.1mm	terminal	silver Phosphor copper plating silver

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**YIYUAN**

深圳市怡远科技有限公司

SHENZHEN YIYUAN TECHNOLOGY CO.,LTD

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CIRCUIT DIAGRAM

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